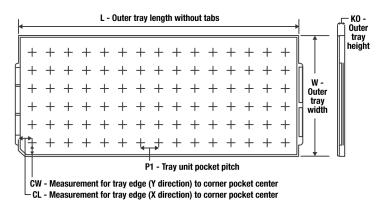


Carrier Material Report for MSP430F413IPM

Tray Information:



Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Type			Array	Temp						(mm)
					Matrix	(°C)						
MSP430	PM	LQFP	64	160	8 X 20	150	315	135.9	7620	15.2	13.1	13
F413IPM												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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